



Vincotech

10-PY12NMA160SH09-M820F98Y

datasheet

flowMNPC 1

1200 V / 160 A

Features

- High reactive power capability
- Low inductance layout
- Split output
- Enhanced LVRT capability

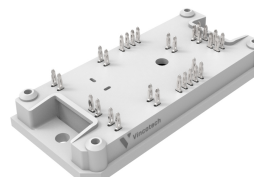
Target applications

- Solar Inverters

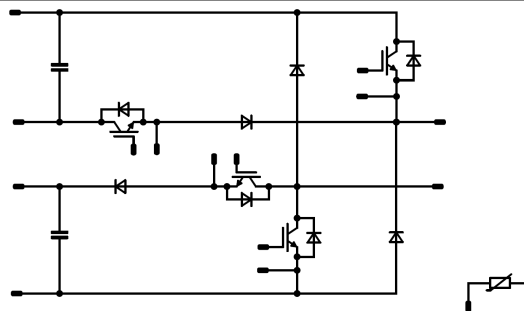
Types

- 10-PY12NMA160SH09-M820F98Y

flow 1 12 mm housing



Schematic





Vincotech

Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Buck Switch				
Collector-emitter voltage	V_{CES}		1200	V
Collector current (DC current)	I_C	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	137	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	480	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	302	W
Gate-emitter voltage	V_{GES}		± 20	V
Short circuit ratings	t_{SC}	$V_{GE} = 15\text{ V}$, $V_{CC} = 800\text{ V}$ $T_j = 150\text{ °C}$	10	μs
Maximum junction temperature	T_{jmax}		175	$^{\circ}\text{C}$

Buck Diode

Peak repetitive reverse voltage	V_{RRM}		650	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	82	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	640	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	105	W
Maximum junction temperature	T_{jmax}		175	$^{\circ}\text{C}$

Buck Sw. Protection Diode

Peak repetitive reverse voltage	V_{RRM}		1200	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	19	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	20	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	46	W
Maximum junction temperature	T_{jmax}		175	$^{\circ}\text{C}$



Vincotech

Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Boost Switch				
Collector-emitter voltage	V_{CES}		650	V
Collector current (DC current)	I_C	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	93	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	640	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	132	W
Gate-emitter voltage	V_{GES}		± 30	V
Short circuit ratings	t_{SC}	$V_{GE} = 15\text{ V}$, $V_{CC} = 360\text{ V}$ $T_j = 25\text{ °C}$	2	μs
Maximum junction temperature	T_{jmax}		175	$^{\circ}\text{C}$

Boost Diode

Peak repetitive reverse voltage	V_{RRM}		1200	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	50	A
Surge (non-repetitive) forward current	I_{FSM}	Single Half Sine Wave, $t_p = 10\text{ ms}$ $T_j = 150\text{ °C}$	340	A
Surge current capability	I^2t		580	A^2s
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	104	W
Maximum junction temperature	T_{jmax}		175	$^{\circ}\text{C}$

Boost Sw. Protection Diode

Peak repetitive reverse voltage	V_{RRM}		650	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	21	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	30	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	40	W
Maximum junction temperature	T_{jmax}		175	$^{\circ}\text{C}$

Capacitor (DC)

Maximum DC voltage	V_{MAX}		630	V
Operation Temperature	T_{op}		-55 ... 125	$^{\circ}\text{C}$



Vincotech

10-PY12NMA160SH09-M820F98Y
datasheet

Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
-----------	--------	------------	-------	------

Module Properties

Thermal Properties

Storage temperature	T_{stg}		-40...+125	°C
Operation temperature under switching condition	T_{jop}		-40...+(T_{jmax} - 25)	°C

Isolation Properties

Isolation voltage	V_{isol}	DC Test Voltage* $t_p = 2\text{ s}$	6000	V
Isolation voltage	V_{isol}	AC Voltage $t_p = 1\text{ min}$	2500	V
Creepage distance			>12,7	mm
Clearance			7,72	mm
Comparative Tracking Index	CTI		≥ 200	

*100 % tested in production



Vincotech

10-PY12NMA160SH09-M820F98Y

datasheet

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	

Buck Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,006	25	5,3	5,8	6,3	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		160	25 125 150	1,78	1,94 2,23 2,32	2,42 ⁽¹⁾	V
Collector-emitter cut-off current	I_{CES}		0	1200		25			20	µA
Gate-emitter leakage current	I_{GES}		20	0		25			480	nA
Internal gate resistance	r_g							None		Ω
Input capacitance	C_{ies}	$f = 1 \text{ Mhz}$	0	25		25		9320		pF
Output capacitance	C_{oes}							600		pF
Reverse transfer capacitance	C_{res}							520		pF
Gate charge	Q_g	$V_{CC} = 960 \text{ V}$	15		160	25		740		nC

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						0,31		K/W
--	---------------	---	--	--	--	--	--	------	--	-----

Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 4 \Omega$ $R_{goff} = 4 \Omega$	± 15	350	160	25 125 150		136 139 138		ns
Rise time	t_r					25 125 150		32 34 36		ns
Turn-off delay time	$t_{d(off)}$					25 125 150		211 250 260		ns
Fall time	t_f					25 125 150		40,78 60,42 67,19		ns
Turn-on energy (per pulse)	E_{on}					25 125 150		3,85 4,58 5,32		mWs
Turn-off energy (per pulse)	E_{off}					25 125 150		4,06 5,76 6,39		mWs



Vincotech

10-PY12NMA160SH09-M820F98Y

datasheet

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	

Buck Diode

Static

Forward voltage	V_F				160	25 125 150		1,55 1,62 1,61	1,9 ⁽¹⁾	V
Reverse leakage current	I_R	$V_i = 650$ V				25			20	μA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						0,91		K/W
--	---------------	---------------------------------------	--	--	--	--	--	------	--	-----

Dynamic

Peak recovery current	I_{RRM}	$di/dt=5150$ A/μs $di/dt=4397$ A/μs $di/dt=4035$ A/μs	± 15	350	160	25 125 150		117,08 126,42 129,78		A
Reverse recovery time	t_{rr}					25 125 150		72,65 134,9 151,31		ns
Recovered charge	Q_r					25 125 150		4,77 7,65 8,72		μC
Reverse recovered energy	E_{rec}					25 125 150		0,86 1,45 1,68		mWs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					25 125 150		4481 3055 2711		A/μs



Vincotech

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	

Buck Sw. Protection Diode

Static

Forward voltage	V_F				10	25 125 150	1,35	1,79 1,77 1,73	2,05 ⁽¹⁾	V
Reverse leakage current	I_R	$V_i = 1200$ V				25			2,7	µA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						2,07		K/W
--	---------------	---------------------------------------	--	--	--	--	--	------	--	-----



Vincotech

10-PY12NMA160SH09-M820F98Y

datasheet

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]		Min	Typ	Max	

Boost Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$			5	0,1142	25	5	6	7	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		160	25 125 150		1,64 1,69 1,75	1,9 ⁽¹⁾	V
Collector-emitter cut-off current	I_{CES}		0	650		25			20	µA
Gate-emitter leakage current	I_{GES}		30	0		25			400	nA
Internal gate resistance	r_g							None		Ω
Input capacitance	C_{ies}	$f = 1 \text{ Mhz}$	0	30		25		9620		pF
Output capacitance	C_{oes}							368		pF
Reverse transfer capacitance	C_{res}							158		pF
Gate charge	Q_g		15	400	160	25		342		nC

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						0,72		K/W
--	---------------	---	--	--	--	--	--	------	--	-----

Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 8 \Omega$ $R_{goff} = 8 \Omega$	± 15	350	160	25 125 150		147 146 146		ns
Rise time	t_r					25 125 150		27 29 29		ns
Turn-off delay time	$t_{d(off)}$					25 125 150		124 132 134		ns
Fall time	t_f					25 125 150		29,4 40,54 44,97		ns
Turn-on energy (per pulse)	E_{on}					25 125 150		1,8 2,3 2,39		mWs
Turn-off energy (per pulse)	E_{off}					25 125 150		2,33 3,24 3,44		mWs



Vincotech

10-PY12NMA160SH09-M820F98Y

datasheet

Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	

Boost Diode

Static

Forward voltage	V_F				70	25 125 150		2,28 2,41 2,37	2,62 ⁽¹⁾ 2,62 ⁽¹⁾	V
Reverse leakage current	I_R	$V_i = 1200$ V				25 150		5400	120 11000	µA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						0,92		K/W
--	---------------	---------------------------------------	--	--	--	--	--	------	--	-----

Dynamic

Peak recovery current	I_{RRM}	$di/dt=6393$ A/µs $di/dt=5363$ A/µs	± 15	350	160	25 125 150		134,46 151,57 159,08		A
Reverse recovery time	t_{rr}					25 125 150		54,76 92,75 153,6		ns
Recovered charge	Q_r					25 125 150		4,56 10,26 11,6		µC
Reverse recovered energy	E_{rec}					25 125 150		0,898 2,55 2,89		mWs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					25 125 150		7853 5712 5545		A/µs



Vincotech

Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]		Min	Typ	Max	

Boost Sw. Protection Diode

Static

Forward voltage	V_F				15	25 125		1,23	1,79 1,67	1,87 ⁽¹⁾	V
Reverse leakage current	I_R	$V_r = 650$ V				25				0,18	μA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						2,36			K/W
--	---------------	---------------------------------------	--	--	--	--	--	------	--	--	-----

Capacitor (DC)

Static

Capacitance	C	DC bias voltage = 0 V				25		100			nF
Tolerance							-10		10		%

Thermistor

Static

Rated resistance	R					25		22			kΩ
Deviation of R_{100}	$\Delta R/R$	$R_{100} = 1484$ Ω				100	-5		5		%
Power dissipation	P							5			mW
Power dissipation constant	d					25		1,5			mW/K
B-value	$B_{(25/50)}$	Tol. ± 1 %						3962			K
B-value	$B_{(25/100)}$	Tol. ± 1 %						4000			K
Vincotech Thermistor Reference										I	

⁽¹⁾ Value at chip level

⁽²⁾ Only valid with pre-applied Vincotech thermal interface material.



Vincotech

10-PY12NMA160SH09-M820F98Y datasheet

Buck Switch Characteristics

figure 1. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

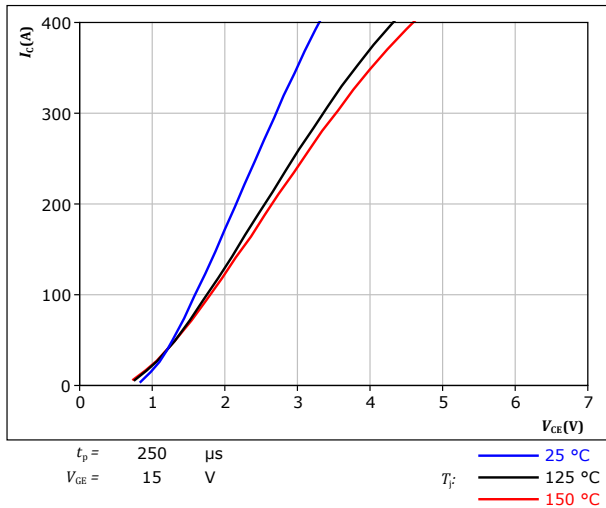


figure 2. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

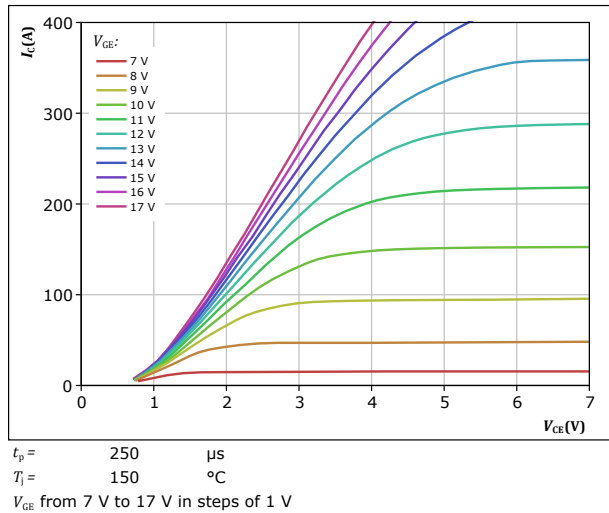


figure 3. IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$

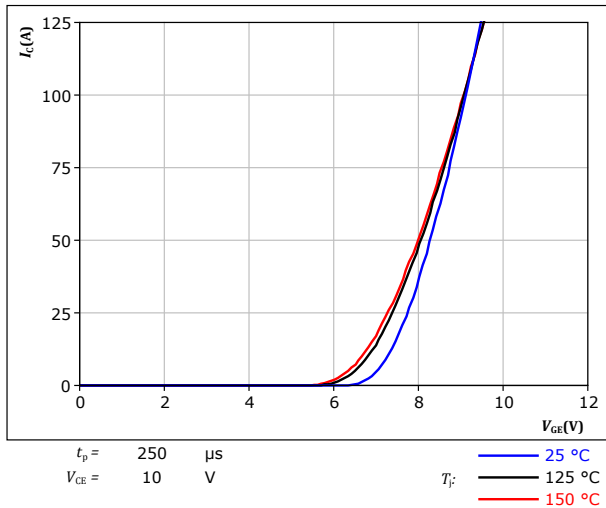
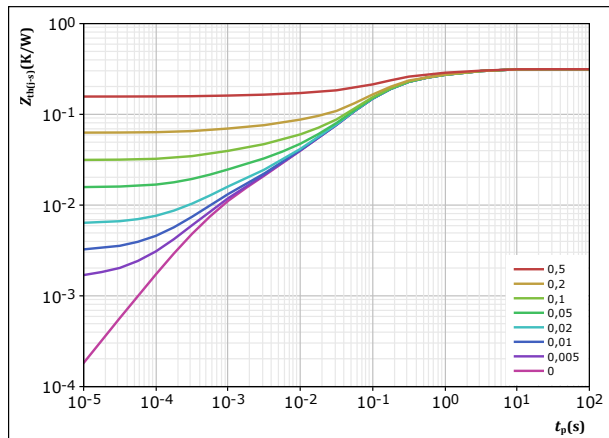


figure 4. IGBT

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



IGBT thermal model values	
R (K/W)	τ (s)
5,90E-02	2,20E+00
7,71E-02	3,38E-01
1,55E-01	9,10E-02
1,55E-02	5,12E-03
7,89E-03	5,92E-04



Vincotech

10-PY12NMA160SH09-M820F98Y
datasheet

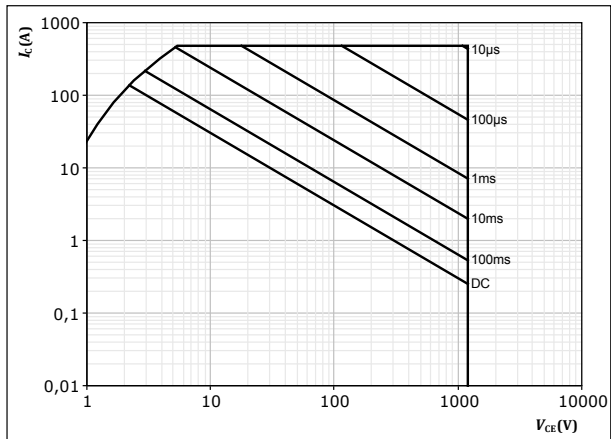
Buck Switch Characteristics

figure 5.

IGBT

Safe operating area

$$I_C = f(V_{CE})$$



D = single pulse

$T_s = 80$ °C
 $V_{GE} = 15$ V
 $T_j = T_{jmax}$



Vincotech

10-PY12NMA160SH09-M820F98Y

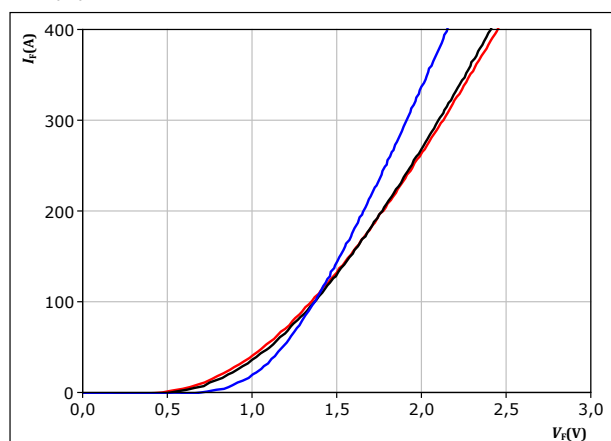
datasheet

Buck Diode Characteristics

figure 6. FWD

Typical forward characteristics

$$I_F = f(V_F)$$



$t_p = 250 \mu s$

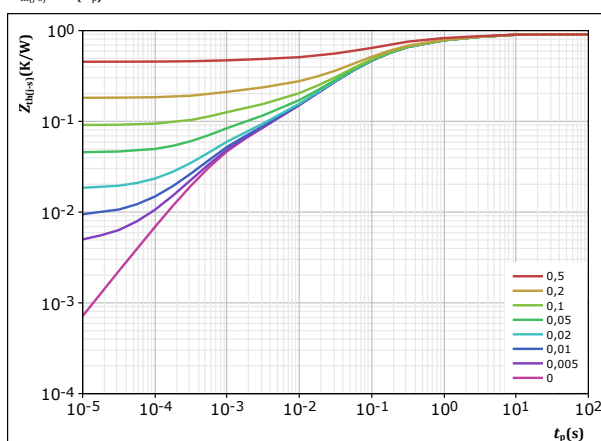
$T_F:$

- 25 °C
- 125 °C
- 150 °C

figure 7. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$

$R_{th(j-s)} = 0,908 \text{ K/W}$

FWD thermal model values

$R \text{ (K/W)}$	$\tau \text{ (s)}$
1,44E-01	3,21E+00
2,39E-01	4,06E-01
3,84E-01	8,31E-02
9,23E-02	1,18E-02
4,87E-02	8,28E-04



Vincotech

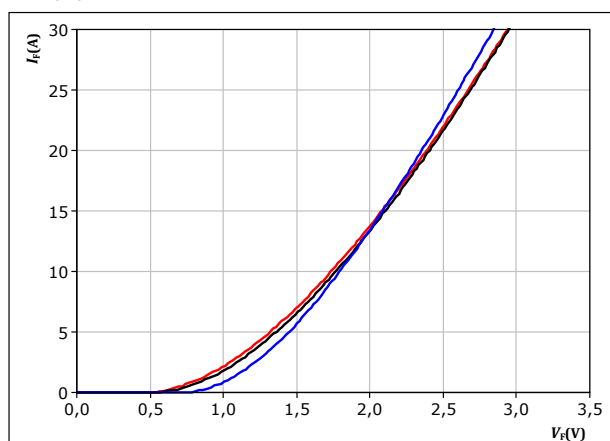
10-PY12NMA160SH09-M820F98Y datasheet

Buck Sw. Protection Diode Characteristics

figure 8. FWD

Typical forward characteristics

$$I_F = f(V_F)$$



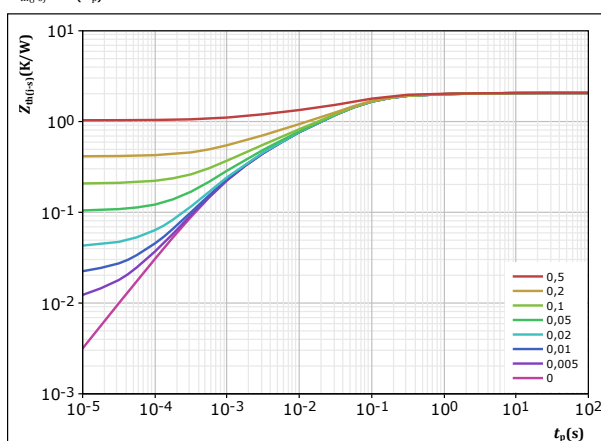
$t_p = 250 \mu s$

T_j : 25 °C, 125 °C, 150 °C

figure 9. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$

$R_{th(j-s)} = 2,066 \text{ K/W}$

FWD thermal model values

R (K/W)	τ (s)
5,09E-02	4,26E+00
1,55E-01	5,03E-01
7,75E-01	7,89E-02
5,33E-01	2,68E-02
3,54E-01	5,03E-03
1,97E-01	9,09E-04



Vincotech

10-PY12NMA160SH09-M820F98Y

datasheet

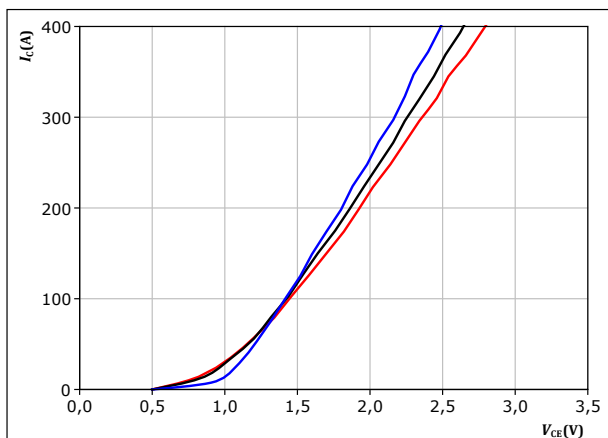
Boost Switch Characteristics

figure 10.

IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$



$t_p = 250 \mu s$
 $V_{GE} = 15 V$

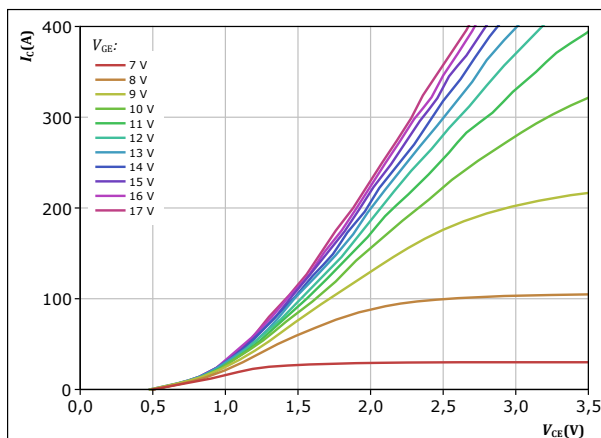
T_j : 25 °C
125 °C
150 °C

figure 11.

IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$



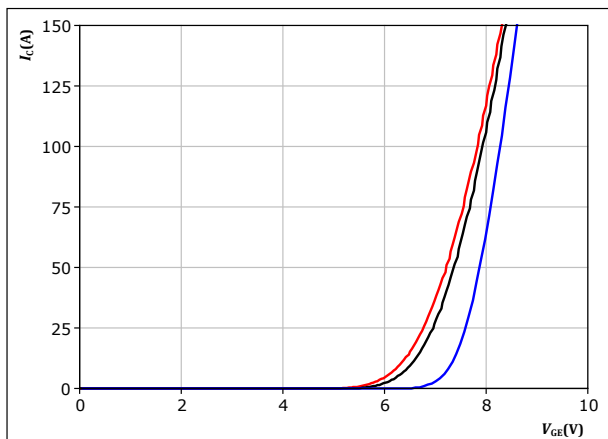
$t_p = 250 \mu s$
 $T_j = 150 ^\circ C$
 V_{GE} from 7 V to 17 V in steps of 1 V

figure 12.

IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$



$t_p = 250 \mu s$
 $V_{CE} = 10 V$

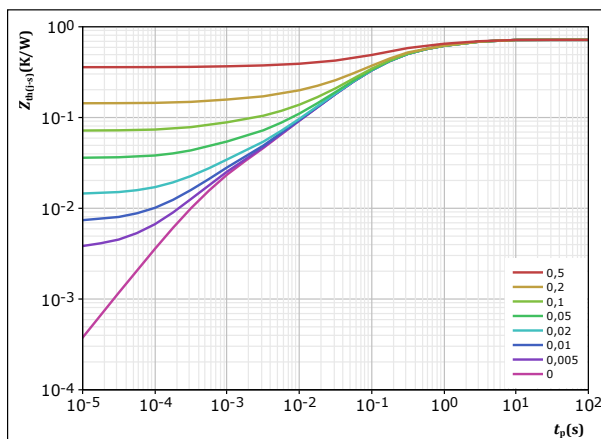
T_j : 25 °C
125 °C
150 °C

figure 13.

IGBT

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 0,718 K/W$
IGBT thermal model values

$R (K/W)$	$\tau (s)$
1,06E-01	2,45E+00
1,53E-01	6,14E-01
3,11E-01	1,37E-01
9,72E-02	3,49E-02
3,40E-02	6,36E-03
1,64E-02	6,05E-04



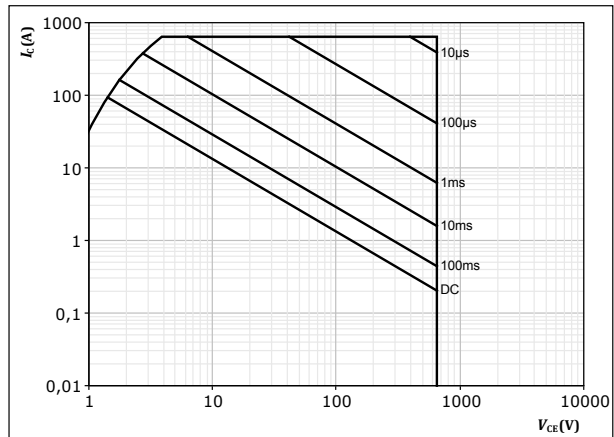
Vincotech

Boost Switch Characteristics

figure 14. IGBT

Safe operating area

$$I_C = f(V_{CE})$$



D = single pulse

$T_s = 80$ °C

$V_{GE} = 15$ V

$T_j = T_{jmax}$



Vincotech

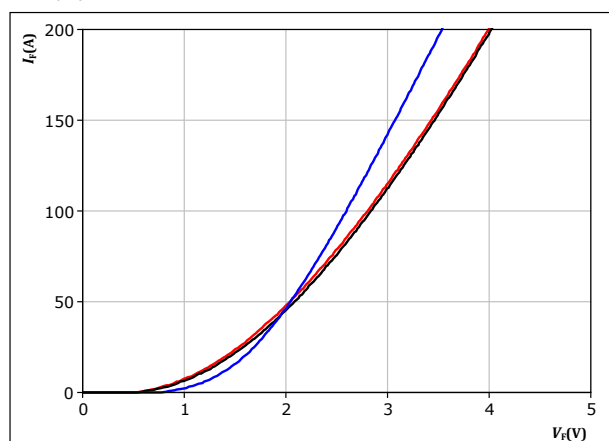
Boost Diode Characteristics

figure 15.

FWD

Typical forward characteristics

$$I_F = f(V_F)$$



$t_p = 250 \mu s$

$T_j:$

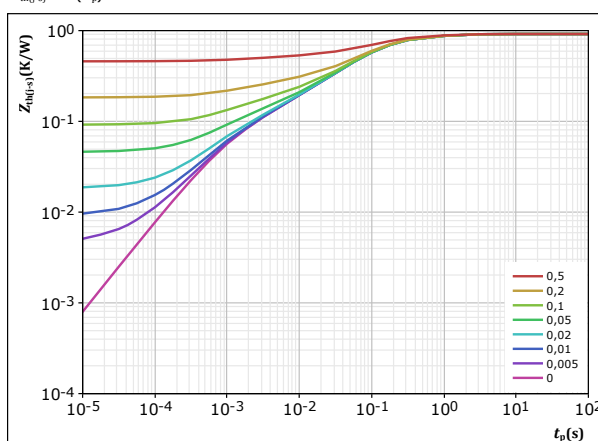
- 25 °C
- 125 °C
- 150 °C

figure 16.

FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$

$R_{th(j-s)} = 0,917 \text{ K/W}$

FWD thermal model values

R (K/W)	τ (s)
1,15E-01	1,01E+00
3,98E-01	1,45E-01
2,68E-01	5,21E-02
7,83E-02	6,35E-03
5,82E-02	9,74E-04



Vincotech

10-PY12NMA160SH09-M820F98Y datasheet

Boost Sw. Protection Diode Characteristics

figure 17.

FWD

Typical forward characteristics

$$I_F = f(V_F)$$

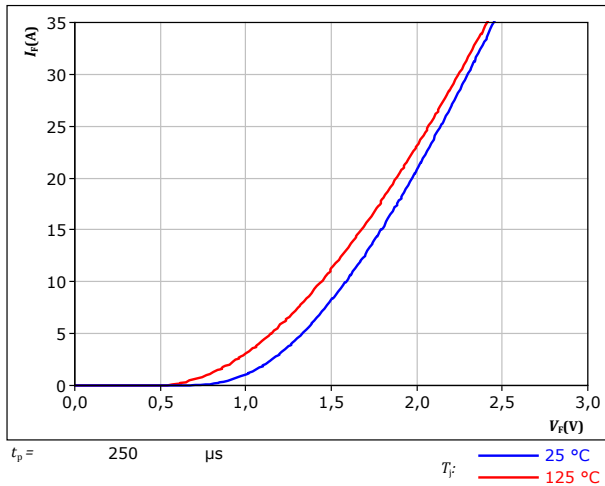
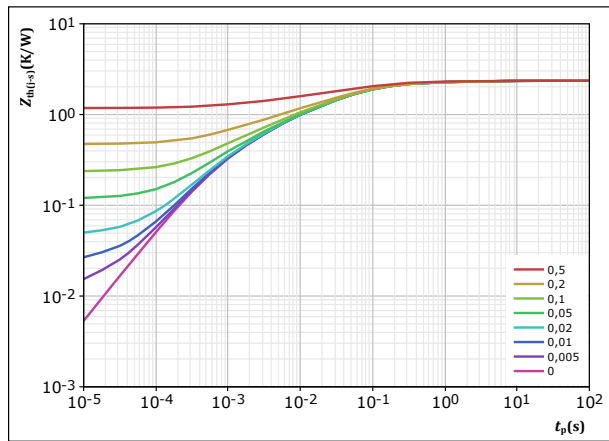


figure 18.

FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$





Vincotech

10-PY12NMA160SH09-M820F98Y
datasheet

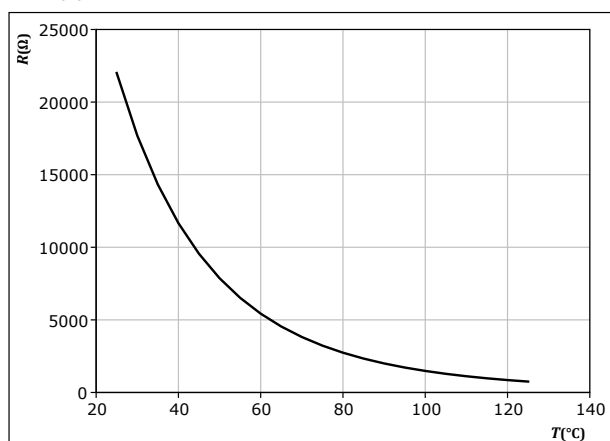
Thermistor Characteristics

figure 19.

Thermistor

Typical NTC characteristic as function of temperature

$$R_T = f(T)$$





Vincotech

10-PY12NMA160SH09-M820F98Y

datasheet

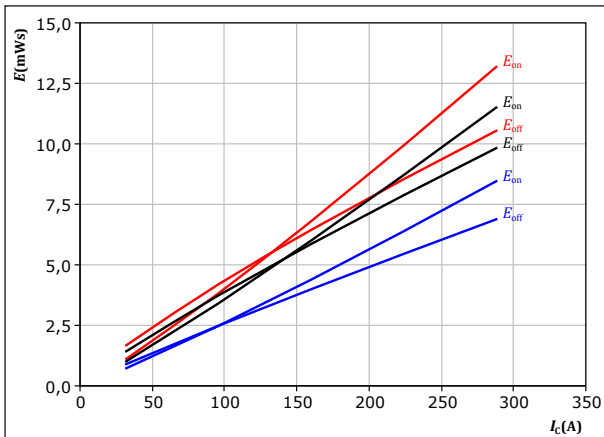
Buck Switching Characteristics

figure 20.

IGBT

Typical switching energy losses as a function of collector current

$$E = f(I_C)$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 4$ Ω
 $R_{goff} = 4$ Ω

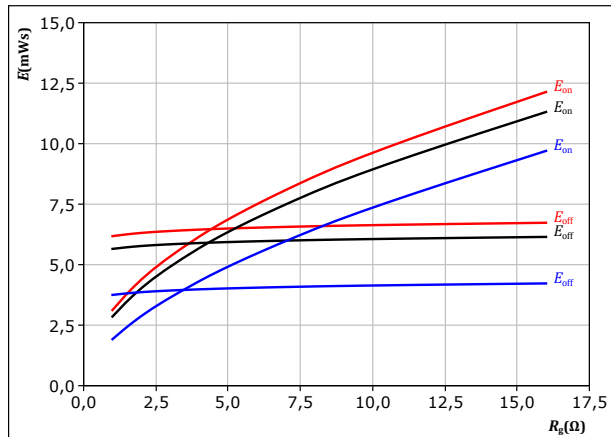
T_j : 25 °C (blue), 125 °C (black), 150 °C (red)

figure 21.

IGBT

Typical switching energy losses as a function of gate resistor

$$E = f(R_g)$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_C = 160$ A

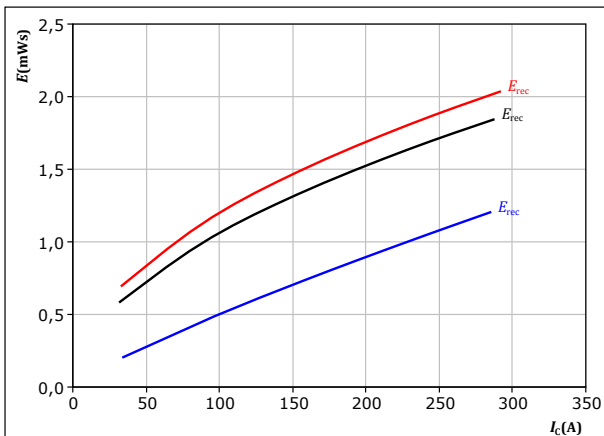
T_j : 25 °C (blue), 125 °C (black), 150 °C (red)

figure 22.

FWD

Typical reverse recovered energy loss as a function of collector current

$$E_{rec} = f(I_C)$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 4$ Ω

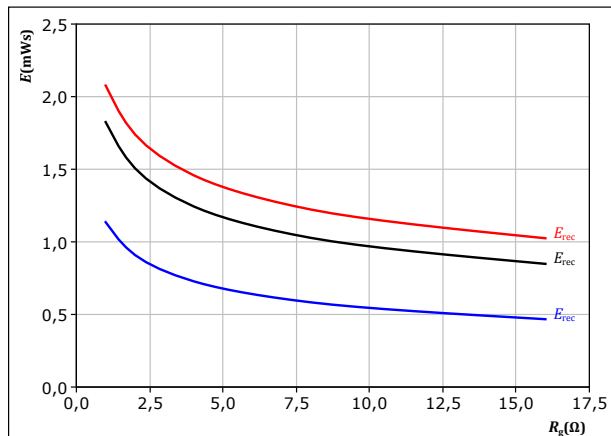
T_j : 25 °C (blue), 125 °C (black), 150 °C (red)

figure 23.

FWD

Typical reverse recovered energy loss as a function of gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_C = 160$ A

T_j : 25 °C (blue), 125 °C (black), 150 °C (red)



Vincotech

10-PY12NMA160SH09-M820F98Y datasheet

Buck Switching Characteristics

figure 24.

IGBT

Typical switching times as a function of collector current
 $t = f(I_C)$

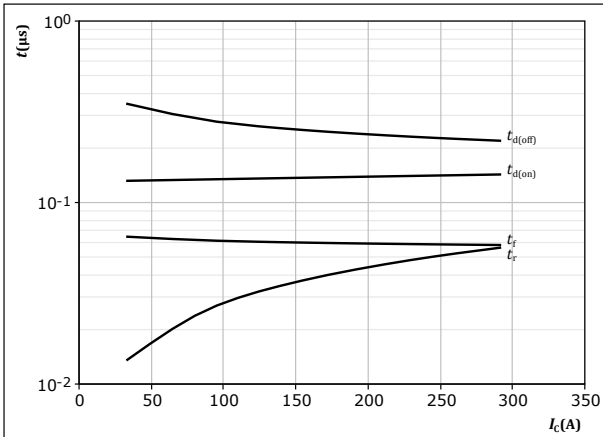


figure 25.

IGBT

Typical switching times as a function of gate resistor
 $t = f(R_g)$

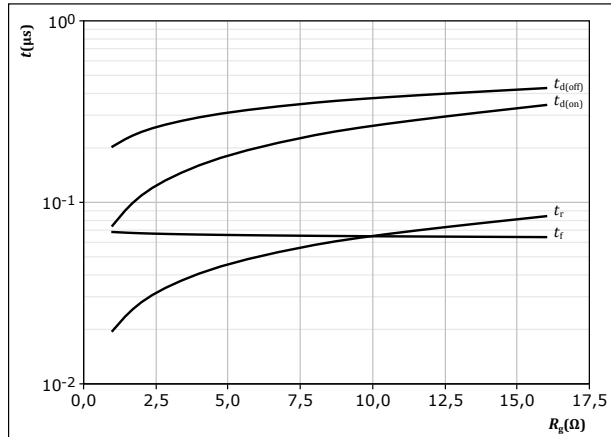


figure 26.

FWD

Typical reverse recovery time as a function of collector current
 $t_{rr} = f(I_C)$

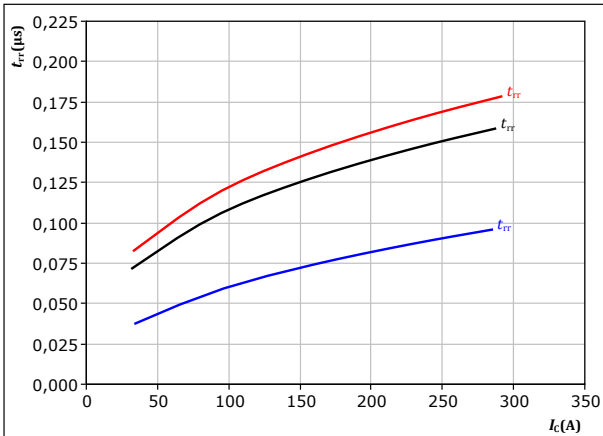
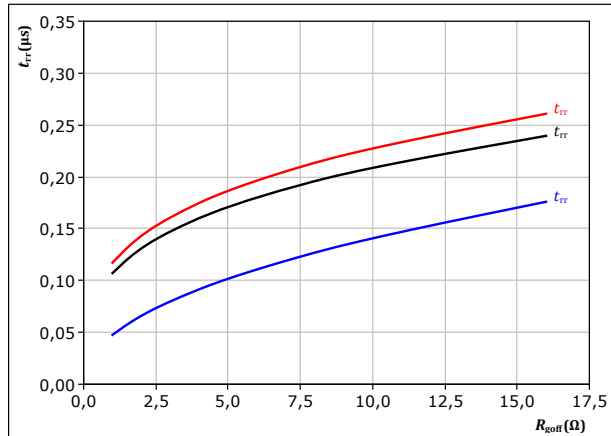


figure 27.

FWD

Typical reverse recovery time as a function of IGBT turn off gate resistor
 $t_{rr} = f(R_{goff})$





Vincotech

10-PY12NMA160SH09-M820F98Y

datasheet

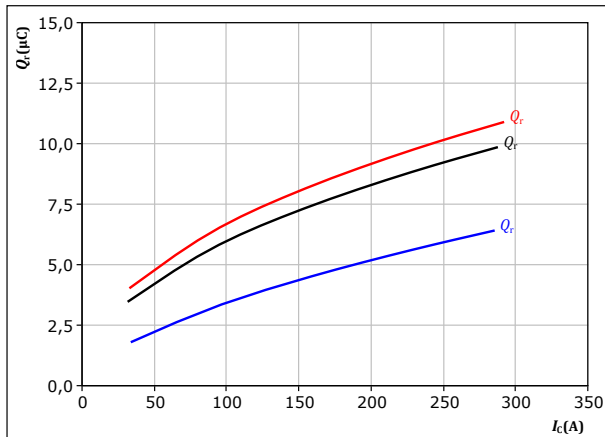
Buck Switching Characteristics

figure 28.

FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 4$ Ω

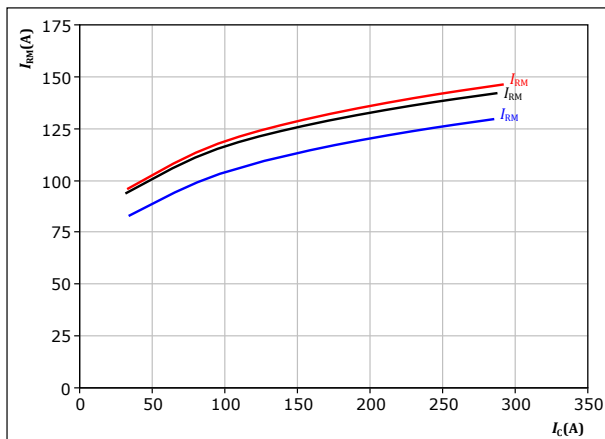
T_j : 25 °C
125 °C
150 °C

figure 30.

FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 4$ Ω

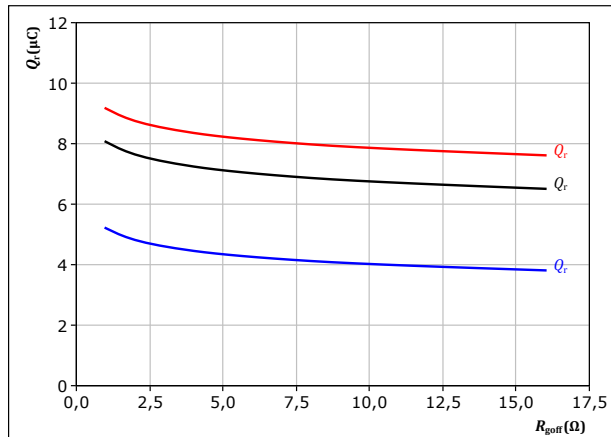
T_j : 25 °C
125 °C
150 °C

figure 29.

FWD

Typical recovered charge as a function of turn off gate resistor

$$Q_r = f(R_{goff})$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_c = 160$ A

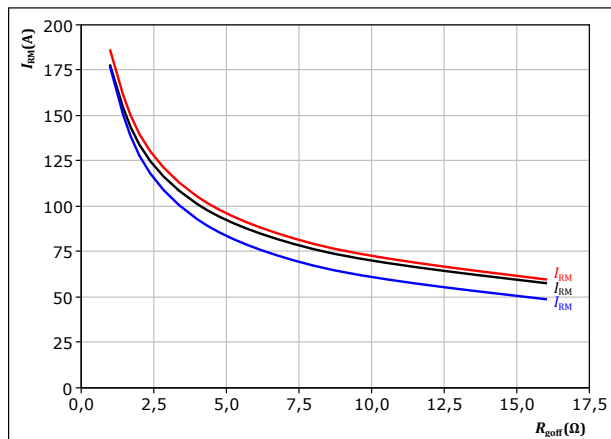
T_j : 25 °C
125 °C
150 °C

figure 31.

FWD

Typical peak reverse recovery current as a function of turn off gate resistor

$$I_{RM} = f(R_{goff})$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_c = 160$ A

T_j : 25 °C
125 °C
150 °C



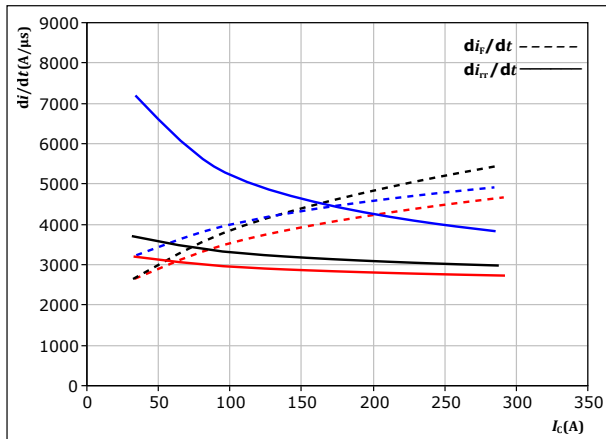
Vincotech

10-PY12NMA160SH09-M820F98Y
datasheet

Buck Switching Characteristics

figure 32. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_r/dt = f(I_C)$



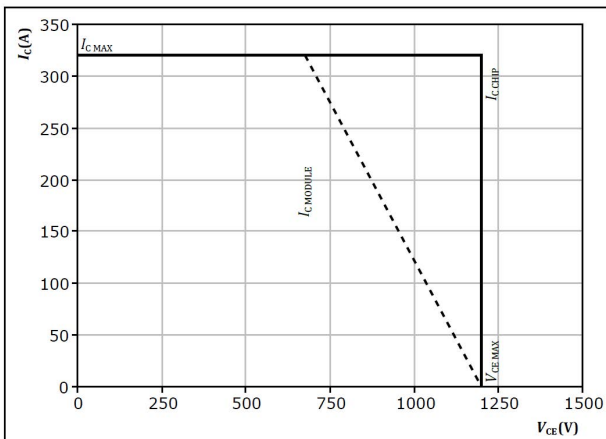
With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 4$ Ω
 $T_j = 25$ °C
 $T_j = 125$ °C
 $T_j = 150$ °C

figure 34. IGBT

Reverse bias safe operating area

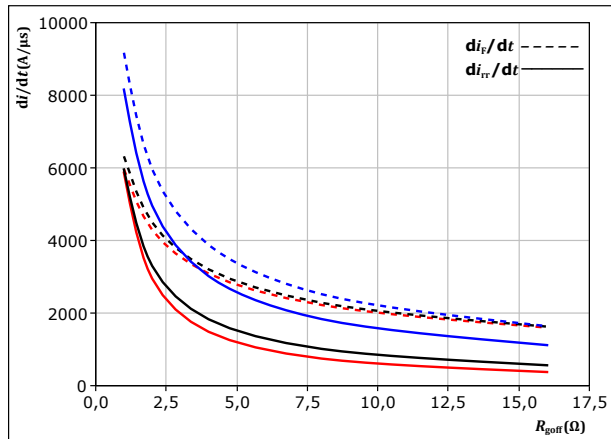
$I_C = f(V_{CE})$



At $T_j = 150$ °C
 $R_{gon} = 4$ Ω
 $R_{goff} = 4$ Ω

figure 33. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn off gate resistor
 $di_f/dt, di_r/dt = f(R_{goff})$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_C = 160$ A
 $T_j = 25$ °C
 $T_j = 125$ °C
 $T_j = 150$ °C



Vincotech

10-PY12NMA160SH09-M820F98Y datasheet

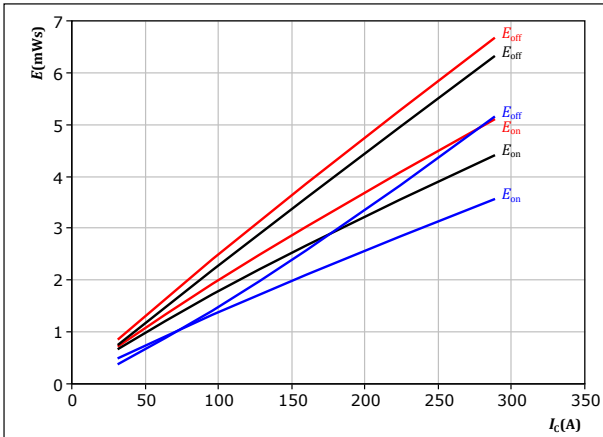
Boost Switching Characteristics

figure 35.

IGBT

Typical switching energy losses as a function of collector current

$$E = f(I_c)$$



With an inductive load at

$V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 8 \text{ } \Omega$
 $R_{goff} = 8 \text{ } \Omega$

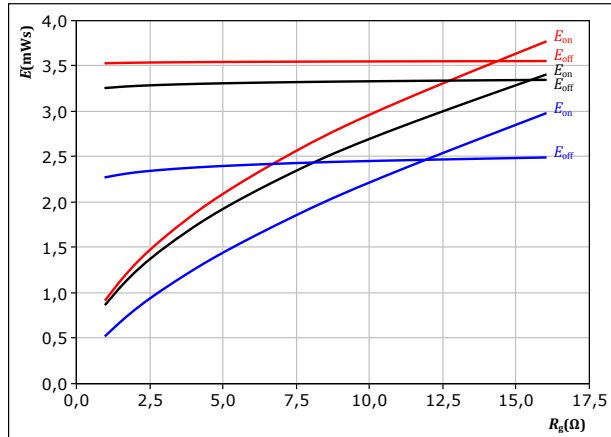
T_j :
— 25 °C
— 125 °C
— 150 °C

figure 36.

IGBT

Typical switching energy losses as a function of gate resistor

$$E = f(R_g)$$



With an inductive load at

$V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_c = 160 \text{ A}$

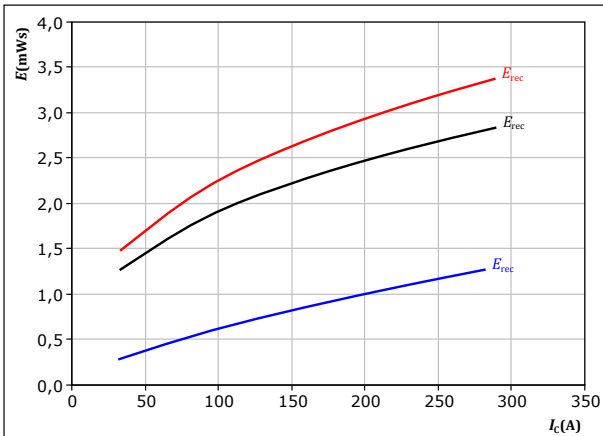
T_j :
— 25 °C
— 125 °C
— 150 °C

figure 37.

FWD

Typical reverse recovered energy loss as a function of collector current

$$E_{rec} = f(I_c)$$



With an inductive load at

$V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{gon} = 8 \text{ } \Omega$

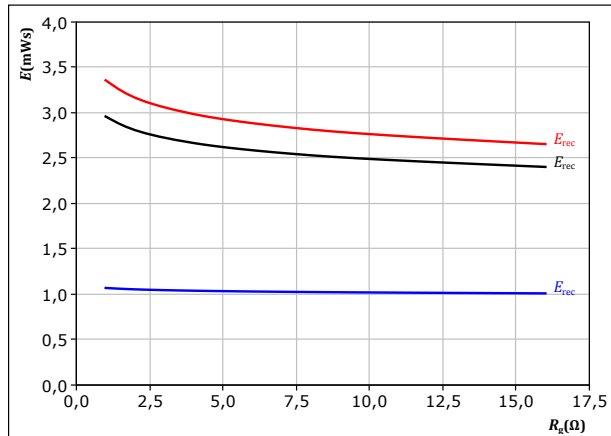
T_j :
— 25 °C
— 125 °C
— 150 °C

figure 38.

FWD

Typical reverse recovered energy loss as a function of gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at

$V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_c = 160 \text{ A}$

T_j :
— 25 °C
— 125 °C
— 150 °C



Vincotech

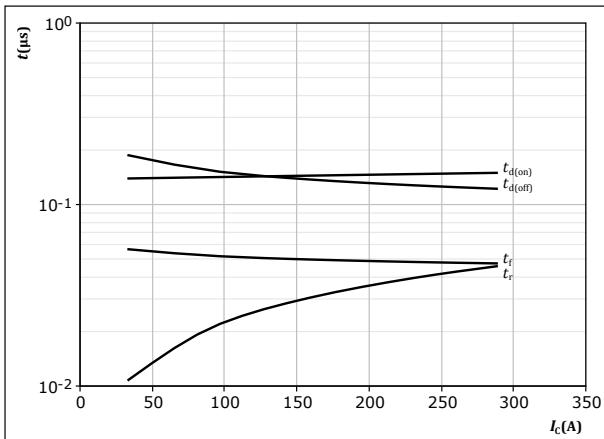
10-PY12NMA160SH09-M820F98Y

datasheet

Boost Switching Characteristics

figure 39. IGBT

Typical switching times as a function of collector current
 $t = f(I_c)$

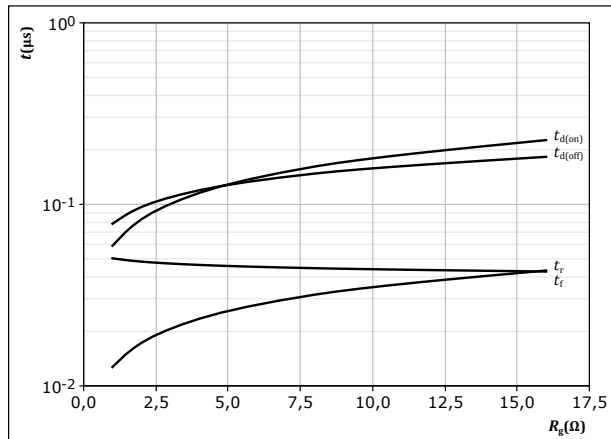


With an inductive load at

$T_j = 150$ °C
 $V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 8$ Ω
 $R_{goff} = 8$ Ω

figure 40. IGBT

Typical switching times as a function of gate resistor
 $t = f(R_g)$

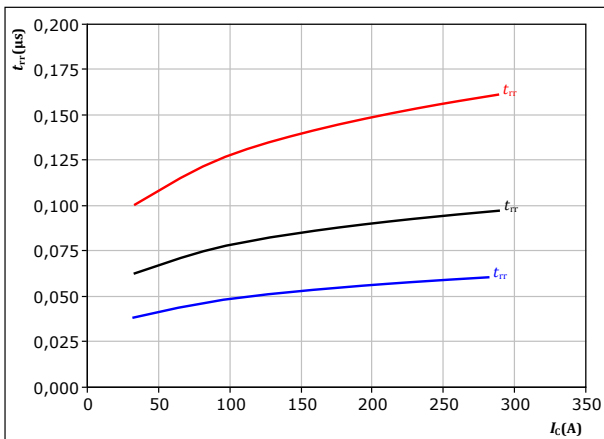


With an inductive load at

$T_j = 150$ °C
 $V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_c = 160$ A

figure 41. FWD

Typical reverse recovery time as a function of collector current
 $t_{rr} = f(I_c)$



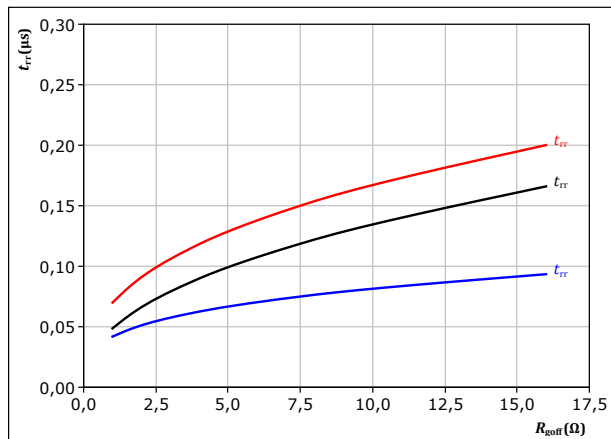
With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 8$ Ω

T_j :
— 25 °C
— 125 °C
— 150 °C

figure 42. FWD

Typical reverse recovery time as a function of IGBT turn off gate resistor
 $t_{rr} = f(R_{goff})$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_c = 160$ A

T_j :
— 25 °C
— 125 °C
— 150 °C



Vincotech

10-PY12NMA160SH09-M820F98Y

datasheet

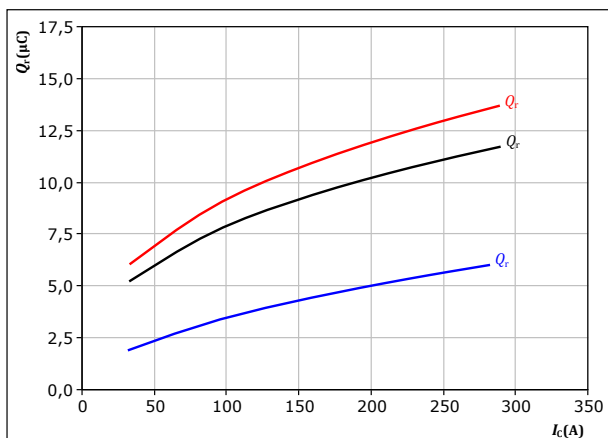
Boost Switching Characteristics

figure 43.

FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_C)$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 8$ Ω

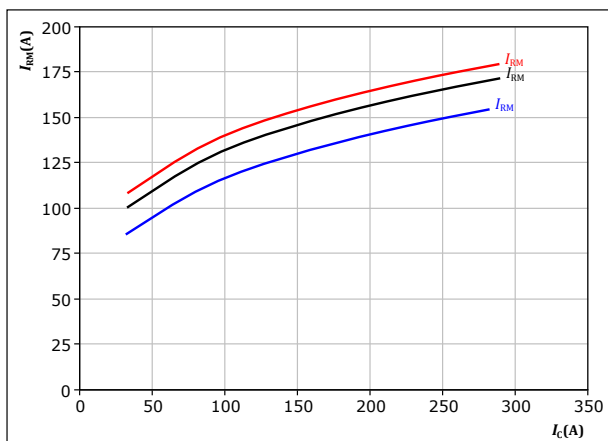
T_j : 25 °C
125 °C
150 °C

figure 45.

FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_C)$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 8$ Ω

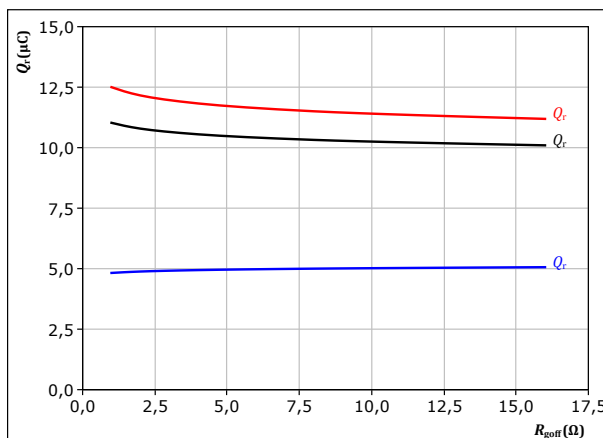
T_j : 25 °C
125 °C
150 °C

figure 44.

FWD

Typical recovered charge as a function of turn off gate resistor

$$Q_r = f(R_{goff})$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_C = 160$ A

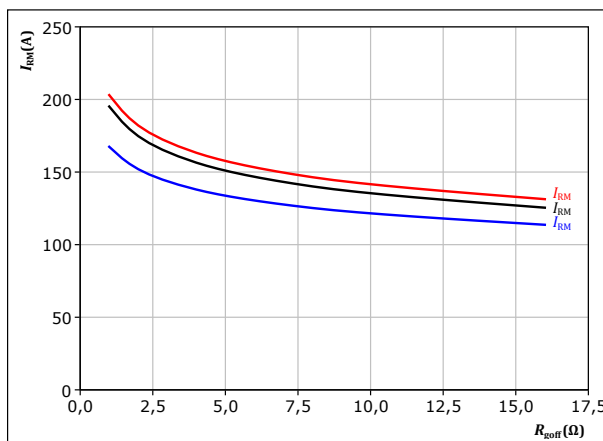
T_j : 25 °C
125 °C
150 °C

figure 46.

FWD

Typical peak reverse recovery current as a function of turn off gate resistor

$$I_{RM} = f(R_{goff})$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_C = 160$ A

T_j : 25 °C
125 °C
150 °C



Vincotech

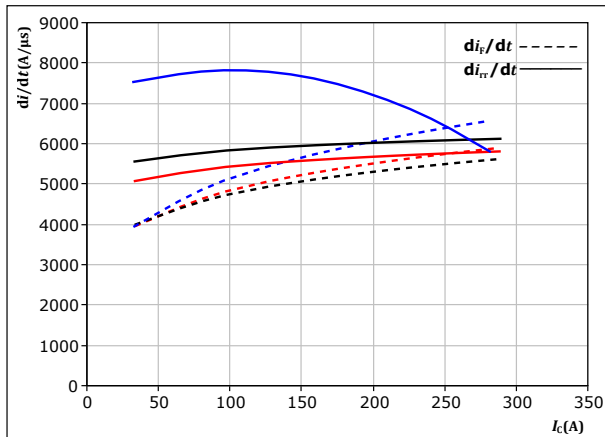
10-PY12NMA160SH09-M820F98Y

datasheet

Boost Switching Characteristics

figure 47. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_r/dt = f(I_C)$



With an inductive load at

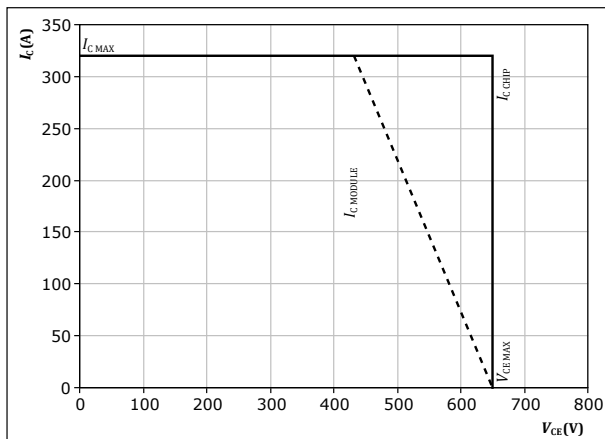
$V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $R_{g\text{on}} = 8 \text{ } \Omega$

$T_j = 25 \text{ } ^\circ\text{C}$
 $125 \text{ } ^\circ\text{C}$
 $150 \text{ } ^\circ\text{C}$

figure 49. IGBT

Reverse bias safe operating area

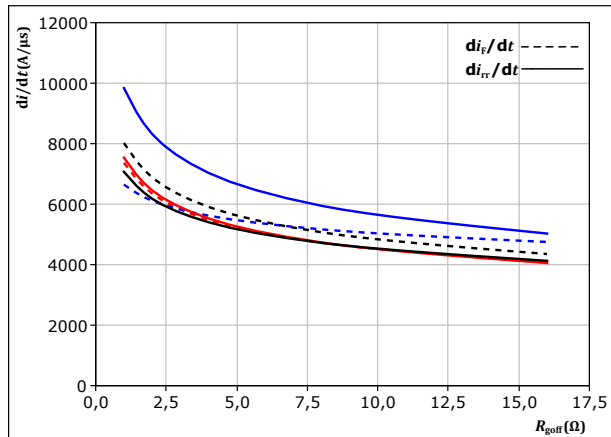
$I_C = f(V_{CE})$



At $T_j = 150 \text{ } ^\circ\text{C}$
 $R_{g\text{on}} = 8 \text{ } \Omega$
 $R_{g\text{off}} = 8 \text{ } \Omega$

figure 48. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn off gate resistor
 $di_f/dt, di_r/dt = f(R_{g\text{off}})$



With an inductive load at

$V_{CE} = 350 \text{ V}$
 $V_{GE} = \pm 15 \text{ V}$
 $I_C = 160 \text{ A}$

$T_j = 25 \text{ } ^\circ\text{C}$
 $125 \text{ } ^\circ\text{C}$
 $150 \text{ } ^\circ\text{C}$



Vincotech

10-PY12NMA160SH09-M820F98Y datasheet

Switching Definitions

figure 50. IGBT

Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff} (t_{Eoff} = integrating time for E_{off})

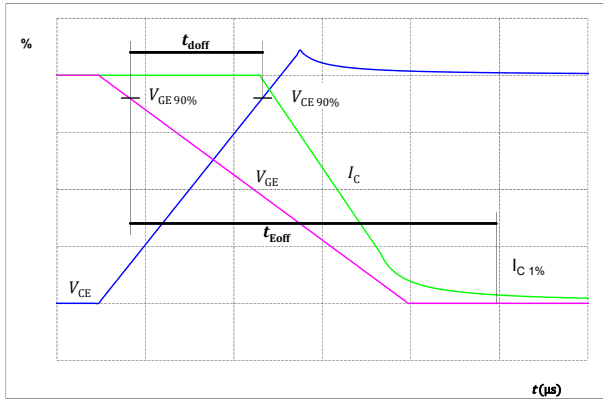


figure 51. IGBT

Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for E_{on})

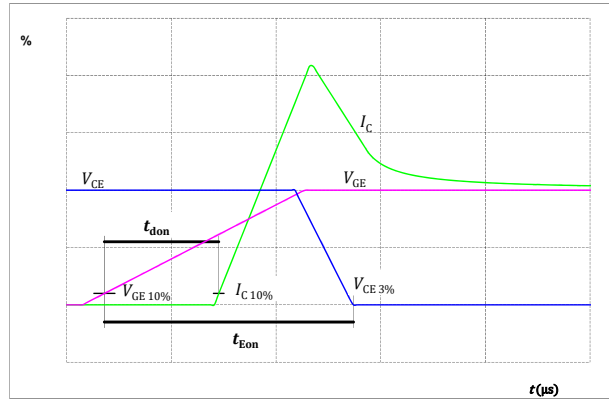


figure 52. IGBT

Turn-off Switching Waveforms & definition of t_f

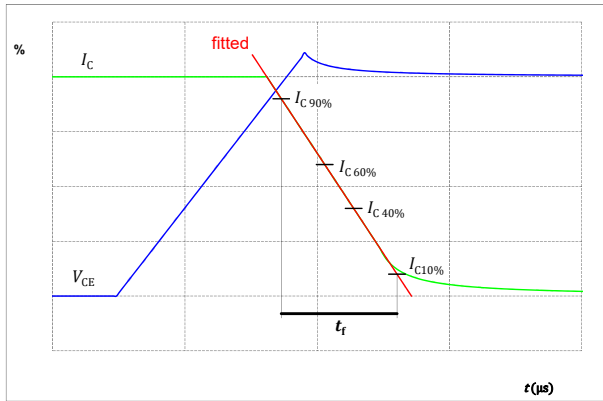
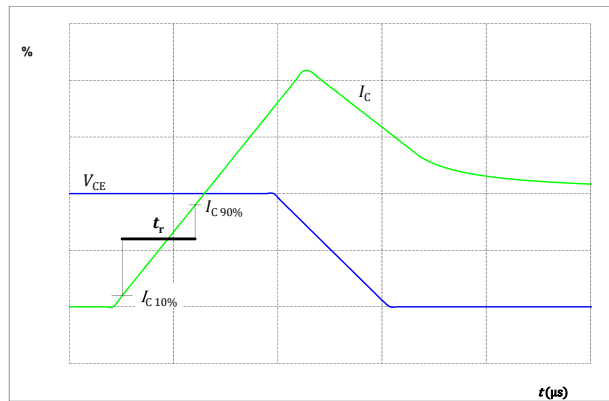


figure 53. IGBT

Turn-on Switching Waveforms & definition of t_r





Vincotech

Switching Definitions

figure 54.

FWD

Turn-off Switching Waveforms & definition of t_{rr}

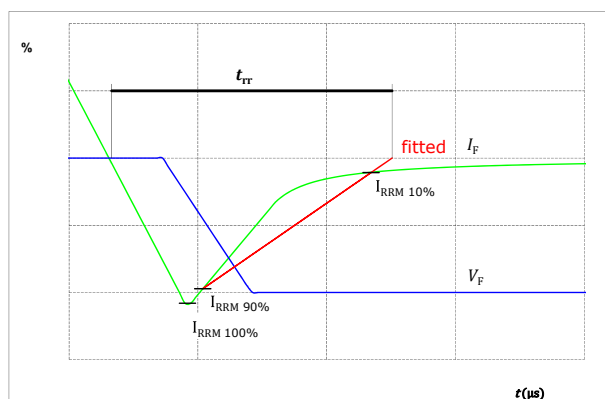
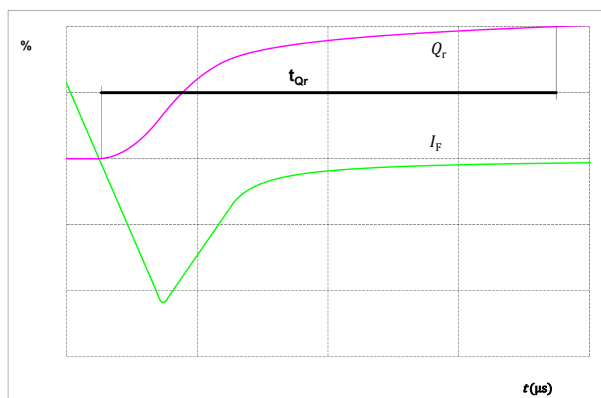


figure 55.

FWD

Turn-on Switching Waveforms & definition of t_{Qr} (t_{Qr} = integrating time for Q_r)






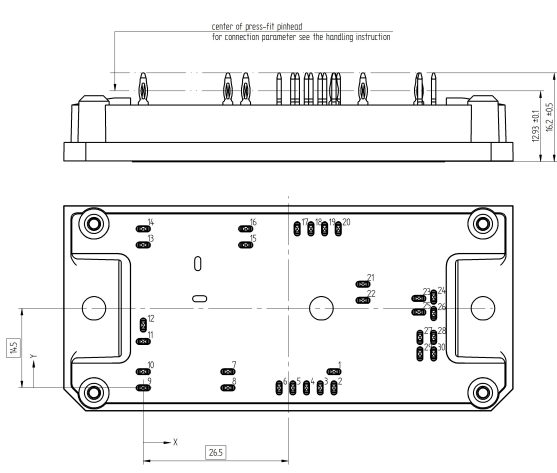
Vincotech

10-PY12NMA160SH09-M820F98Y

datasheet

Ordering Code	
Version	Ordering Code
Without thermal paste	10-PY12NMA160SH09-M820F98Y
With thermal paste	10-PY12NMA160SH09-M820F98Y-/3/

Marking					
	Text	Name NN-NNNNNNNNNNNNNN- TTTTTVV	Date code WWYY	UL & VIN UL VIN	Lot LLLLL
	Datamatrix	Type&Ver TTTTTTVV	Lot number LLLLL	Serial SSSS	Date code WWYY

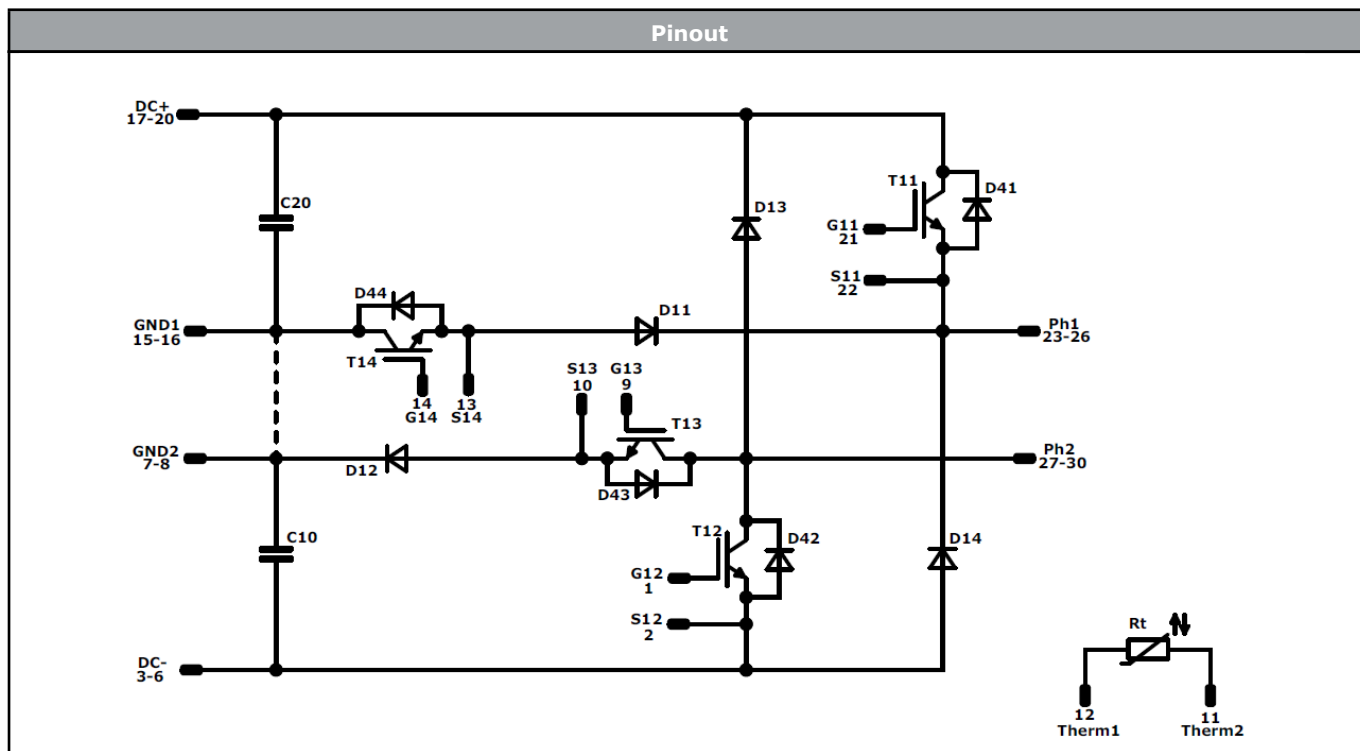
Outline																																																																																																																															
<p>Pin table [mm]</p> <table><thead><tr><th>Pin</th><th>X</th><th>Y</th><th>Function</th></tr></thead><tbody><tr><td>1</td><td>34,8</td><td>2,95</td><td>G12</td></tr><tr><td>2</td><td>34,8</td><td>0</td><td>S12</td></tr><tr><td>3</td><td>32,3</td><td>0</td><td>DC-</td></tr><tr><td>4</td><td>29,8</td><td>0</td><td>DC-</td></tr><tr><td>5</td><td>27,3</td><td>0</td><td>DC-</td></tr><tr><td>6</td><td>24,8</td><td>0</td><td>DC-</td></tr><tr><td>7</td><td>15,45</td><td>2,95</td><td>GND2</td></tr><tr><td>8</td><td>15,45</td><td>0</td><td>GND2</td></tr><tr><td>9</td><td>0</td><td>0</td><td>G13</td></tr><tr><td>10</td><td>0</td><td>2,95</td><td>S13</td></tr><tr><td>11</td><td>0</td><td>8,45</td><td>Therm2</td></tr><tr><td>12</td><td>0</td><td>11,45</td><td>Therm1</td></tr><tr><td>13</td><td>0</td><td>26,05</td><td>S14</td></tr><tr><td>14</td><td>0</td><td>29</td><td>G14</td></tr><tr><td>15</td><td>18,7</td><td>26,05</td><td>GND1</td></tr><tr><td>16</td><td>18,7</td><td>29</td><td>GND1</td></tr><tr><td>17</td><td>28,1</td><td>29</td><td>DC+</td></tr><tr><td>18</td><td>30,6</td><td>29</td><td>DC+</td></tr><tr><td>19</td><td>33,1</td><td>29</td><td>DC+</td></tr><tr><td>20</td><td>35,6</td><td>29</td><td>DC+</td></tr><tr><td>21</td><td>40,1</td><td>18,9</td><td>G11</td></tr><tr><td>22</td><td>40,1</td><td>15,95</td><td>S11</td></tr><tr><td>23</td><td>50,3</td><td>16,3</td><td>Ph1</td></tr><tr><td>24</td><td>53</td><td>16,55</td><td>Ph1</td></tr><tr><td>25</td><td>50,3</td><td>13,8</td><td>Ph1</td></tr><tr><td>26</td><td>53</td><td>13,55</td><td>Ph1</td></tr><tr><td>27</td><td>50,5</td><td>9,2</td><td>Ph2</td></tr><tr><td>28</td><td>53</td><td>9,2</td><td>Ph2</td></tr><tr><td>29</td><td>50,5</td><td>6,2</td><td>Ph2</td></tr><tr><td>30</td><td>53</td><td>6,2</td><td>Ph2</td></tr></tbody></table>				Pin	X	Y	Function	1	34,8	2,95	G12	2	34,8	0	S12	3	32,3	0	DC-	4	29,8	0	DC-	5	27,3	0	DC-	6	24,8	0	DC-	7	15,45	2,95	GND2	8	15,45	0	GND2	9	0	0	G13	10	0	2,95	S13	11	0	8,45	Therm2	12	0	11,45	Therm1	13	0	26,05	S14	14	0	29	G14	15	18,7	26,05	GND1	16	18,7	29	GND1	17	28,1	29	DC+	18	30,6	29	DC+	19	33,1	29	DC+	20	35,6	29	DC+	21	40,1	18,9	G11	22	40,1	15,95	S11	23	50,3	16,3	Ph1	24	53	16,55	Ph1	25	50,3	13,8	Ph1	26	53	13,55	Ph1	27	50,5	9,2	Ph2	28	53	9,2	Ph2	29	50,5	6,2	Ph2	30	53	6,2	Ph2
Pin	X	Y	Function																																																																																																																												
1	34,8	2,95	G12																																																																																																																												
2	34,8	0	S12																																																																																																																												
3	32,3	0	DC-																																																																																																																												
4	29,8	0	DC-																																																																																																																												
5	27,3	0	DC-																																																																																																																												
6	24,8	0	DC-																																																																																																																												
7	15,45	2,95	GND2																																																																																																																												
8	15,45	0	GND2																																																																																																																												
9	0	0	G13																																																																																																																												
10	0	2,95	S13																																																																																																																												
11	0	8,45	Therm2																																																																																																																												
12	0	11,45	Therm1																																																																																																																												
13	0	26,05	S14																																																																																																																												
14	0	29	G14																																																																																																																												
15	18,7	26,05	GND1																																																																																																																												
16	18,7	29	GND1																																																																																																																												
17	28,1	29	DC+																																																																																																																												
18	30,6	29	DC+																																																																																																																												
19	33,1	29	DC+																																																																																																																												
20	35,6	29	DC+																																																																																																																												
21	40,1	18,9	G11																																																																																																																												
22	40,1	15,95	S11																																																																																																																												
23	50,3	16,3	Ph1																																																																																																																												
24	53	16,55	Ph1																																																																																																																												
25	50,3	13,8	Ph1																																																																																																																												
26	53	13,55	Ph1																																																																																																																												
27	50,5	9,2	Ph2																																																																																																																												
28	53	9,2	Ph2																																																																																																																												
29	50,5	6,2	Ph2																																																																																																																												
30	53	6,2	Ph2																																																																																																																												
 <p>center of press-fit pinhead for connection parameter see the handling instruction</p> <p>12,93 ±0,1 8,2 ±0,5</p> <p>14,5 26,5</p> <p>Tolerance of pinposition: ±0,5mm at the end of pins Dimension of coordinate axis is only offset without tolerance</p>																																																																																																																															



10-PY12NMA160SH09-M820F98Y

datasheet

Vincotech



Identification					
ID	Component	Voltage	Current	Function	Comment
T11, T12	IGBT	1200 V	160 A	Buck Switch	
D11, D12	FWD	650 V	160 A	Buck Diode	
D41, D42	FWD	1200 V	10 A	Buck Sw. Protection Diode	
T13, T14	IGBT	650 V	160 A	Boost Switch	
D13, D14	FWD	1200 V	70 A	Boost Diode	
D43, D44	FWD	650 V	15 A	Boost Sw. Protection Diode	
C10, C20	Capacitor	630 V		Capacitor (DC)	
Rt	NTC			Thermistor	



Vincotech

10-PY12NMA160SH09-M820F98Y
datasheet

Packaging instruction				
Standard packaging quantity (SPQ) 100	>SPQ	Standard	<SPQ	Sample

Handling instruction
Handling instructions for <i>flow 1</i> packages see vincotech.com website.

Package data
Package data for <i>flow 1</i> packages see vincotech.com website.

Vincotech thermistor reference
See Vincotech thermistor reference table at vincotech.com website.

UL recognition and file number
This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website.



Document No.:	Date:	Modification:	Pages
10-PY12NMA160SH09-M820F98Y-D4-14	13 May. 2021	Buck switching conditions corrected to $V_{ce}=350V$	

DISCLAIMER

The information, specifications, procedures, methods and recommendations herein (together "information") are presented by Vincotech to reader in good faith, are believed to be accurate and reliable, but may well be incomplete and/or not applicable to all conditions or situations that may exist or occur. Vincotech reserves the right to make any changes without further notice to any products to improve reliability, function or design. No representation, guarantee or warranty is made to reader as to the accuracy, reliability or completeness of said information or that the application or use of any of the same will avoid hazards, accidents, losses, damages or injury of any kind to persons or property or that the same will not infringe third parties rights or give desired results. It is reader's sole responsibility to test and determine the suitability of the information and the product for reader's intended use.

LIFE SUPPORT POLICY

Vincotech products are not authorised for use as critical components in life support devices or systems without the express written approval of Vincotech.

As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in labelling can be reasonably expected to result in significant injury to the user.
2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.